

## T495E477M010ATE040

**General Information** 

Series

Style

Dielectric

Description

Termination

AEC-Q200

Shelf Life

Specifications

Capacitance

Tolerance

Voltage DC

MSL

**Typical Component Weight** 

Features

RoHS

T495, Tantalum, MnO2 Tantalum, Commercial Grade, 470 uF, 20%, 10 VDC, SMD, MnO2, Molded, Large Case, Low ESR, 40 mOhms, 7360, 3.8 mm, 1.3 mm

T495

MnO2 Tantalum

SMD, MnO2, Molded, Large Case, Low ESR

10 VDC (85C), 6.7 VDC (125C)

SMD Chip

Low ESR

803.76 mg

156 Weeks

Yes

Tin

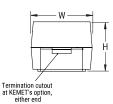
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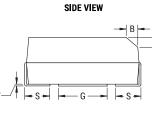
1

470 uF

20%

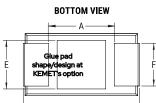
CATHODE (-) END VIEW





ANODE (+) END VIEW





Click here for the 3D model.

Dimensions	
L	7.3mm +/-0.3mm
W	6mm +/-0.3mm
н	3.6mm +/-0.2mm
т	0.13mm REF
S	1.3mm +/-0.3mm
F	4.1mm +/-0.1mm
A	3.6mm MIN
В	0.5mm +/-0.15mm
E	3.5mm REF
G	3.5mm REF
х	0.1mm +/-0.1mm REF

nm REF	Temperature Range	-55/+125°C
m +/-0.3mm	Rated Temperature	85°C
m +/-0.1mm	Dissipation Factor	10% 120Hz 25C
nm MIN	Failure Rate	N/A
nm +/-0.15mm	ESR	40 mOhms (100kHz 25C)
ım REF	Ripple Current	2236 mA (rms, 100kHz 25C), 2012.4 mA (rms, 85C), 894.4 mA
im REF		(rms, 125C)
m +/-0.1mm REF	Leakage Current	47 uA (5min 25°C)

Packaging Specifications		
Packaging	T&R, 178mm	
Packaging Quantity	500	

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute – and we specifically disclaim – any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

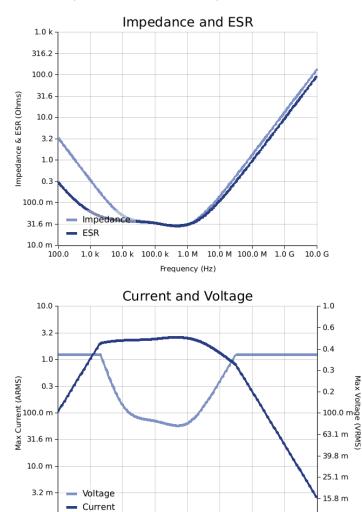


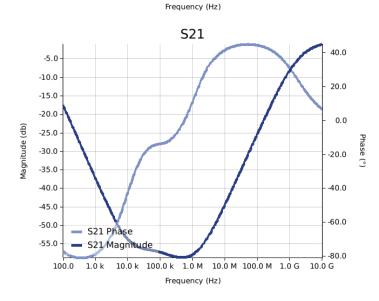
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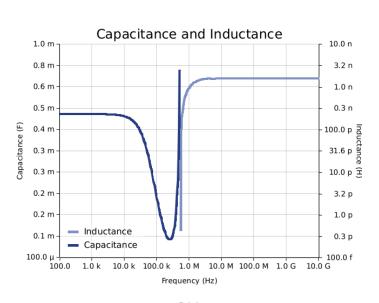
## Simulations

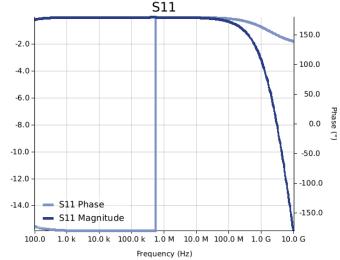
For the complete simulation environment please visit K-SIM.





10.0 k 100.0 k 1.0 M 10.0 M 100.0 M 1.0 G 10.0 G





Magnitude (db)

10.0 m

1.0 m

100.0

1.0 k



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## These are simulations.

This is not a specification!

The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

The responses shown do not represent a specified or implied maximum capability of the device for all applications.

- The ESR used for ripple "Ripple Current/Voltage vs. Frequency" plots is the ESR at ambient temperature.

- The ESR used for hipple klipple current younge vs. requericy plots is the ESR at an bient temperature.
  The ESR in the "Temperature Rise vs. Ripple Current" plots is adjusted to each incremental temperature rise before the power and ripple current is calculated.
  The effects shown herein are based on measured data from a multiple part sample of the parts in question.
  Ripple capability of this device will be factored by thermal resistance (Rth) created by circuit traces (addi affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.
  The peak voltages generated in the "Temperature Rise vs. Combined Ripple Currents" plot are calculated for each frequency and are not combined with voltages and the part of the parts of the part of the
- generated at any other harmonics.
  Please consult with the catalog or field applications engineer for maximum capability of the device in specific applications.

All product information and data (collectively, the "Information") are subject to change without notice.

KEMET K-SIM is designed to simulate behavior of components with respect to frequency, ambient temperature, and DC bias levels. The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation effects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

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If you have any questions please contact K-SIM.